AO4466

30V N-Channel MOSFET

General Description

The AO4466 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance.

* RoHS and Halogen-Free Compliant

Product Summary

 $V_{DS}(V) = 30V$ $I_{D} = 10A$

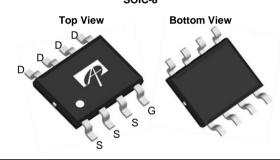
 $(V_{GS} = 10V)$ $(V_{GS} = 10V)$ $(V_{GS} = 4.5V)$ $R_{DS(ON)}$ < 23m Ω

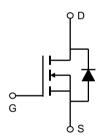
 $R_{DS(ON)} < 35m\Omega$

100% UIS Tested 100% Rg Tested









Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain	T _A =25°C		10		
Current AF	T _A =70°C	I_D	7	А	
Pulsed Drain Current ^B		I _{DM}	64		
	T _A =25°C	P _D	3.1	W	
Power Dissipation	T _A =70°C]' D	2	VV	
Avalanche Current B, G		I _{AR}	12	А	
Repetitive avalanche energy 0.1mH B, G		E _{AR}	7	mJ	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	В	36	40	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$-$ R _{θJA}	62	75	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	18	24	°C/W			



Electrical Characteristics (T_{.1}=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC P	ARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu A,\ V_{GS}=0V$	30			V	
I _{DSS} Z	Zero Gate Voltage Drain Current	V_{DS} =30 V_{GS} =0 V			1	μА	
		T _J =55°C			5		
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250\mu A$	1.5	2.1	2.6	V	
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V	64			Α	
	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =10A		16.7	23		
R _{DS(ON)}		T _J =125°C		24.3	30	mΩ	
		V_{GS} =4.5V, I_D =5A		23.7	35	mΩ	
g _{FS}	Forward Transconductance	V_{DS} =5V, I_D =10A		17		S	
V_{SD}	Diode Forward Voltage	$I_S=1A,V_{GS}=0V$		0.75	1	V	
Is	Maximum Body-Diode Continuous Curr			2.4	Α		
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance		298	373	448	pF	
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz	46	67	88	pF	
C_{rss}	Reverse Transfer Capacitance		24	41	58	pF	
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	0.6	1.8	2.8	Ω	
SWITCHII	NG PARAMETERS						
Q _g (10V)	Total Gate Charge		5.7	7.1	8.6	nC	
Q _g (4.5V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =10A	2.7	3.5	4.2	nC	
Q_{gs}	Gate Source Charge	V _{GS} -10V, V _{DS} -13V, I _D -10A		1.2		nC	
Q_{gd}	Gate Drain Charge			1.6		nC	
t _{D(on)}	Turn-On DelayTime			4.3		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_{L} =1.5 Ω ,		2.8		ns	
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}=3\Omega$		15.8		ns	
t _f	Turn-Off Fall Time			3		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A, dI/dt=100A/μs	8.4	10.5	12.6	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =10A, dI/dt=100A/μs	3.6	4.5	5.4	nC	
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A, dI/dt=500A/μs	4.7	6.0	7.2	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =10A, dI/dt=500A/μs	5.3	6.6	8	nC	

A: The value of R _{0JA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with

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T_A=25° C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

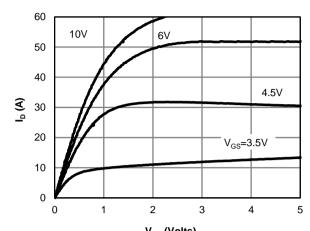
E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25° C. The SOA curve provides a single pulse rating.

F. The current rating is based on the $t \leqslant 10 s$ junction to ambient thermal resistance rating.

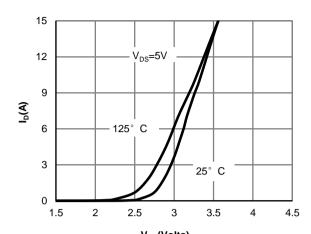
G: L=100uH, V_{DD} =0V, R_{G} =0 Ω , rated V_{DS} =30V and V_{GS} =10V



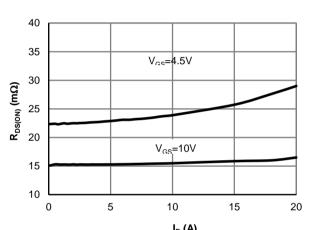
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



 $V_{\rm DS}$ (Volts) Fig 1: On-Region Characteristics



V_{GS}(Volts) Figure 2: Transfer Characteristics



 $\label{eq:ldots} \textbf{I}_{D}\left(\textbf{A}\right)$ Figure 3: On-Resistance vs. Drain Current and Gate Voltage

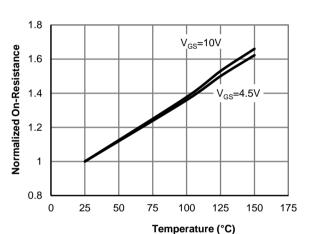
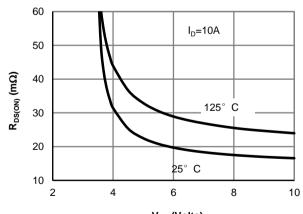
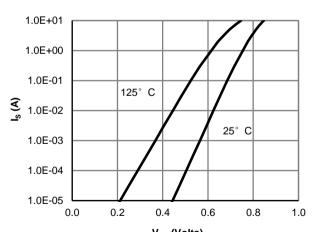


Figure 4: On-Resistance vs. Junction Temperature



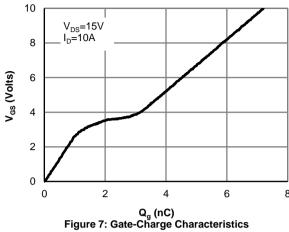
V_{GS} (Volts) Figure 5: On-Resistance vs. Gate-Source Voltage

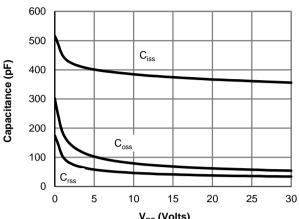


V_{SD} (Volts) Figure 6: Body-Diode Characteristics

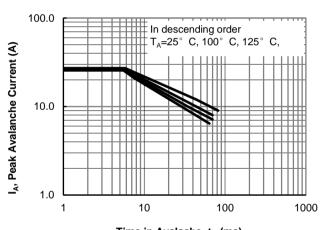


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V_{DS} (Volts)
Figure 8: Capacitance Characteristics



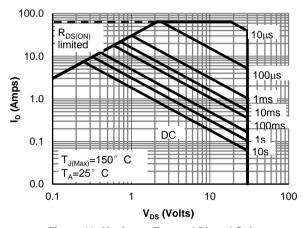


Figure 10: Maximum Forward Biased Safe Operating Area (Note E)

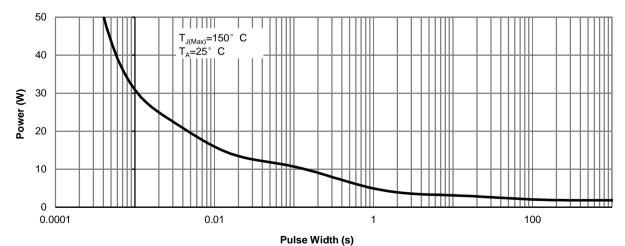


Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note E)



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

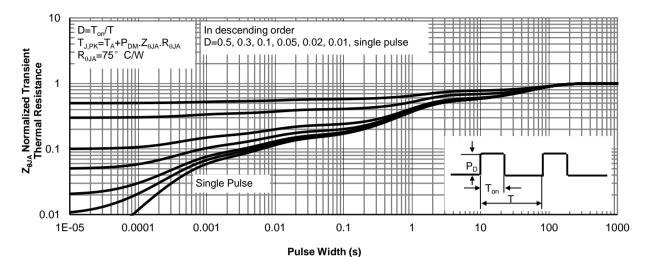
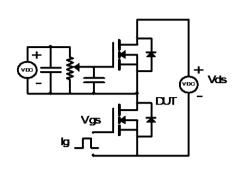
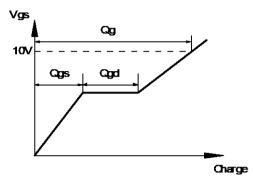


Figure 12: Normalized Maximum Transient Thermal Impedance

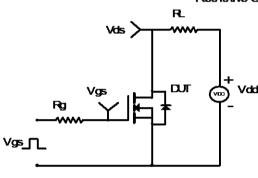


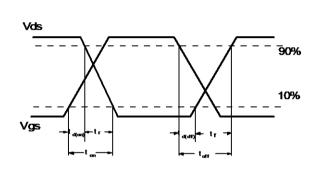
Gate Charge Test Circuit & Waveform



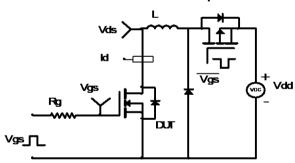


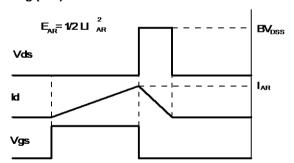
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

